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## Space systems — Cube satellite (CubeSat) interface

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## Foreword

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This document was prepared by Technical Committee ISO/TC 20, *Aircraft and space vehicles*, Subcommittee SC 14, *Space systems and operations*.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at [www.iso.org/members.html](http://www.iso.org/members.html).

## Introduction

This document provides requirements for internal and external interfaces of CubeSat. There is increasing demand of CubeSat development and utilization worldwide. CubeSats are often built with emphasis on low cost and fast delivery. Low cost can be achieved by extensive use of non-space-qualified commercial-off-the-shelf parts and units. Fast delivery is, however, often difficult to achieve when the interface of different units, such as printed circuit board (PCB), do not match each other. The incompatibility can cause significant delay in the satellite project, leading to the loss of business opportunity or academic/technology competition.

There is also increasing trend that a CubeSat platform that contains all the satellite bus functionalities by a single vendor is combined with a mission payload. A common standard on the interface between the CubeSat platform and the mission payload broadens the choice for the those who want to do a space mission but do not want to build a satellite to select the platform depending on their needs. This document makes it easier for CubeSat vendors to enter the market of CubeSat platforms.

This document aims to shorten the time required to design, develop, assemble, integrate and test CubeSat by clarifying the interface from the beginning of the satellite project. The document also aims to promote international trade of CubeSat units/platforms and international collaboration.

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# Space systems — Cube satellite (CubeSat) interface

## 1 Scope

This document describes internal and external interfaces of CubeSat. The internal interface includes the interface between components and the interface between a CubeSat platform and a mission payload. The external interface is limited to the umbilical connectors, i.e. access port. The document also describes the items to be included in the datasheet of the CubeSat components and platforms. The datasheet requirements apply to catalogued commercial products ready for sale.

This document does not cover the interface between CubeSat and its deployer, i.e. POD.

This document is applicable to CubeSats of all sizes.

## 2 Normative references

There are no normative references in this document.

## 3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

- ISO Online browsing platform: available at <https://www.iso.org/obp>
- IEC Electropedia: available at <https://www.electropedia.org/>

**3.1** <https://standards.iteh.ai/catalog/standards/iso/0e3d2262-6f4e-4a94-989e-5d7107d58a0c/iso-fdis-17981>  
**CubeSat**

picosatellite measuring ~~100 mm~~ **100 mm** cubic and weighting ~~1,33 kg~~ **33 kg** or less

[SOURCE: ISO 17770:2017, 3.1], modified — Note 1 to entry has been removed.

### 3.2

#### **CubeSat form factor**

volume unit measuring 100 mm × 100 mm × 100 mm expressed by “U” to describe the volume of each *CubeSat*  
**(3.1)**

### 3.3

#### **1U CubeSat**

##### **single Cubesat**

satellite measuring 100 mm × 100 mm × 113,5 mm and weighing 1,33 kg or less

Note 1 to entry: For the exact external dimension, see ISO 17770.

### 3.4

#### **3U CubeSat**

##### **triple Cubesat**

satellite measuring 100 mm × 100 mm × 340,5 mm and weighing 4,00 kg or less

Note 1 to entry: For the exact external dimension, see ISO 17770.

### 3.5

#### PC-104 style

*CubeSat* (3.1) architecture made of stackable printed circuit boards each of which has a 104-pin connector

Note 1 to entry: PC-104 is originally a specification of embedded computer to define both *CubeSat form factors* (3.2) and computer buses. PC-104 board used in *CubeSat* inherits an approximate size of 90 mm × 90 mm, a stackable 104-pin connector and four mounting holes at the corners from the original PC-104 specification.

### 3.56

#### backplane style

*CubeSat* (3.1) architecture made of one interface PCB at the bottom that is called backplane and other printed circuit boards vertically inserted to the backplane

### 3.67

#### CubeSat platform

combination of *CubeSat* (3.1) units to provide all the necessary satellite bus functionality, such as power, command and data handling, communication, attitude control

### 3.78

#### deployer

box that encloses *CubeSats* (3.1) within a confined volume with a lid at one side that closes the ejection port during the launch phase.

EXAMPLE POD (picosatellite orbital deployer).

[SOURCE: ISO 17770:2017, 3.2, modified — Note 1 to entry has been removed; EXAMPLE has been added.]

## 4 Abbreviated terms

PCB	printed circuit board
GND	ground
AGND	analogue ground
ADCS	attitude determination control system
BPB	backplane board
CAD	computer aided design
<del>CAN</del>	<del>controller area network</del>
<del>CAN</del>	<del>controller area network</del> Commercial off the shelf
COTS	
DGND	digital ground
ECSS	European Cooperation for Space Standardization
EIA	Electronic Industries Alliance
EMC	electromagnetic compatibility
I2C	inter-integrated circuit
ISS	international space station



I/O	input and output
LVDS	low voltage differential signalling
SCL	serial clock
SDA	serial data
SPI	serial peripheral interface
TIA	Telecommunications Industry Association
TRL	technology readiness level
UART	universal asynchronous receiver/transmitter
USB	Universal Serial Bus

## 5 Internal interface requirements

### 5.1 Unit to unit interface

#### 5.1.1 General

The envelope shall have enough clearance or notches between the external panel and the unit so that harness can go through it. A unit shall not rely on the other units to mechanically fix itself. It shall be fixed by poles fixed to the satellite structure though the mounting holes or attached directly to the satellite structure. Connection via harness should be avoided as much as possible. Mating connectors should be available widely in the market. A tool to safely remove the mating connectors shall be available. Ground lines and pins, or grounding point shall be clearly marked and shall have the minimum resistance. In-rush current associated with activation shall be minimized. There should be two or more types of digital communication interfaces and one or more general purpose digital I/O and one or more analogue I/O. Spacing to the neighbouring components shall be enough to avoid collision during vibration.

#### 5.1.2 PC-104 style

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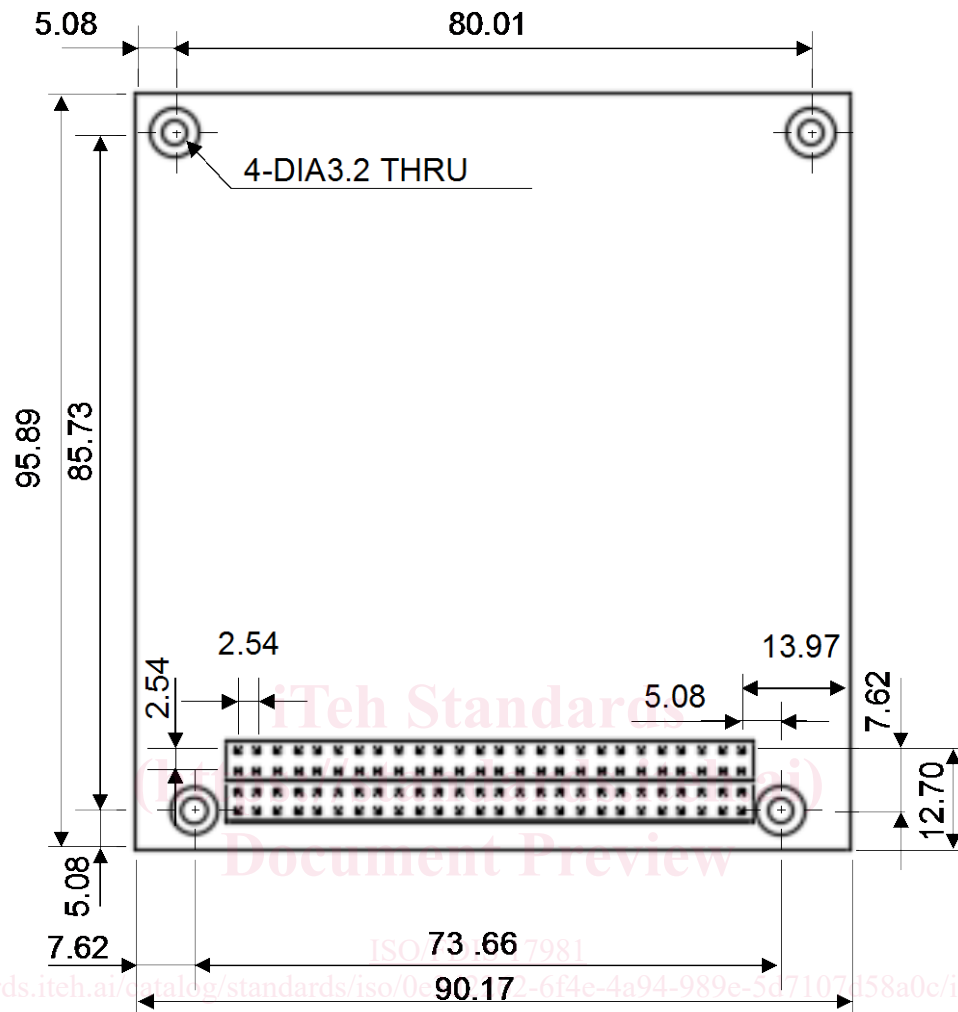
##### 5.1.2.1 General

An example of PC-104 style is given in [Annex B](#).

##### 5.1.2.2 Envelope and mounting holes

Unit shall conform to the maximum envelope of 95,89 mm × 90,17 mm shown in [Figure 1](#). Some part of the four sides should be notched to provide harness routing. Each unit shall be equipped with four mounting holes whose diameter is 3,2 mm or larger. The location of the mounting holes shall be as shown in [Figure 1](#). No parts shall be mounted within 6,4 mm diameter from the centres of the mounting holes. The height of 104-pin female connectors, such as ESQ-126-38-G-D or compatibles, is 11,05 mm as shown in [Figure 2](#). The parts height mounted on the top side (the side with the female connector) should not exceed 11 mm. Some units with tall parts such as ADCS can be necessary to be placed at the top of the stack. If the parts are mounted at the bottom side, the distance B in [Figure 2](#) shall be extended by using a connector with long male connector pins, such as ESQ-126-39-G-D or compatibles, and adjusting the spacer length.

### Dimensions in millimeters



### Dimensions in millimetres

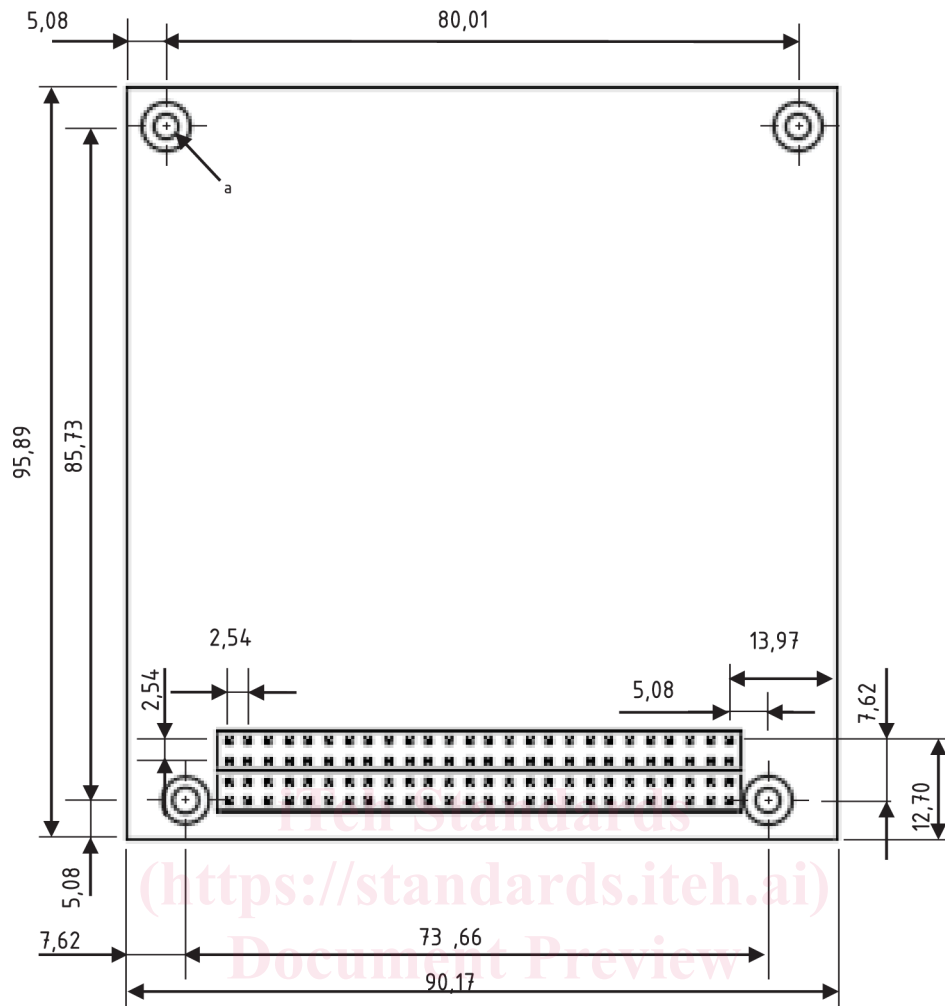
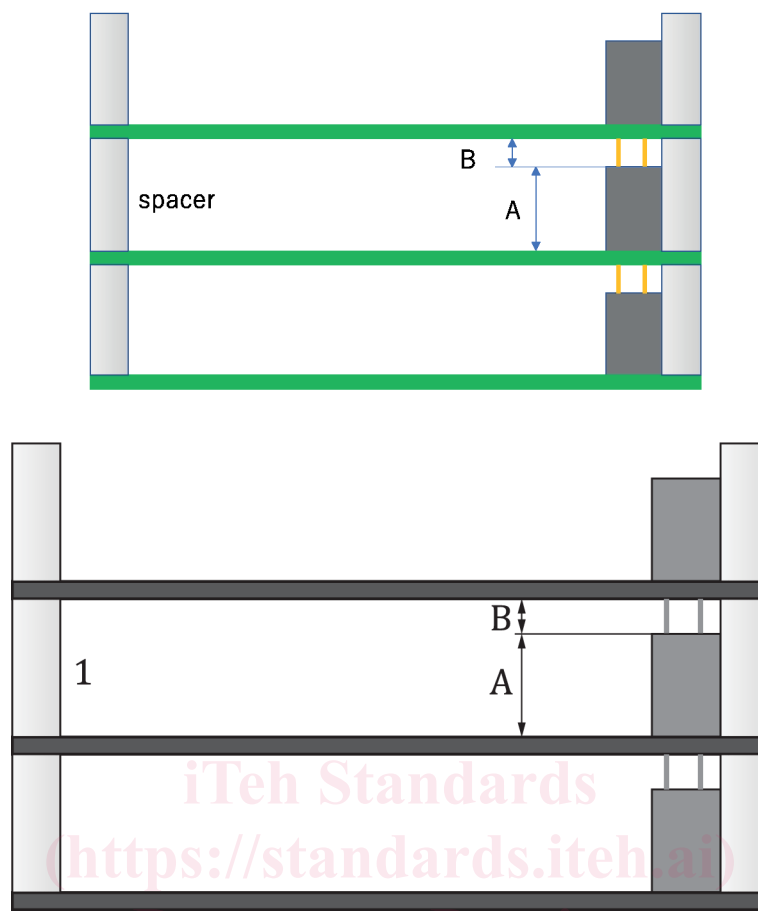


Figure 1 — PC-104 style UNIT

**Key**

1 spacer

**Figure 2 — PC-104 style stacking condition****5.1.2.25.1.2.3 Connector**

Unit shall have a 104-pin connector. The connector is made of two double 26 pin connectors such as ESQ-126-38-G-D or compatibles. The exact location with respect to the mounting holes shall be as shown in [Figure 1](#) ~~Figure 1.~~

**5.1.2.35.1.2.4 Ground lines**

The pin numbers H2-29, H2-30, H2-31, H2-32 shall be allocated to the ground as shown in [Figure 3](#) ~~Figure 3.~~

**5.1.2.45.1.2.5 Power lines**

The pin numbers H2-25 and H2-26 shall be allocated to the regulated power of 5 V. The pin numbers H2-27 and H-28 shall be allocated to the regulated power of 3,3 V, as shown in [Figure 3](#) ~~Figure 3.~~ Other pins may be assigned to deliver the power if necessary.

**5.1.2.55.1.2.6 Analogue lines**

Several pins shall be allocated for analogue data lines for sensing and other purposes.

#### ~~5.1.2.6~~5.1.2.7 Digital lines

The pin number H1-41 shall be allocated to the I<sup>2</sup>C-SDA. The pin number H1-43 shall be allocated to I<sup>2</sup>C-SCL, as shown in ~~Figure 3~~Figure 3. There is a variety of digital communication protocols used in CubeSat. Some are given in ~~Annex A~~Annex A.

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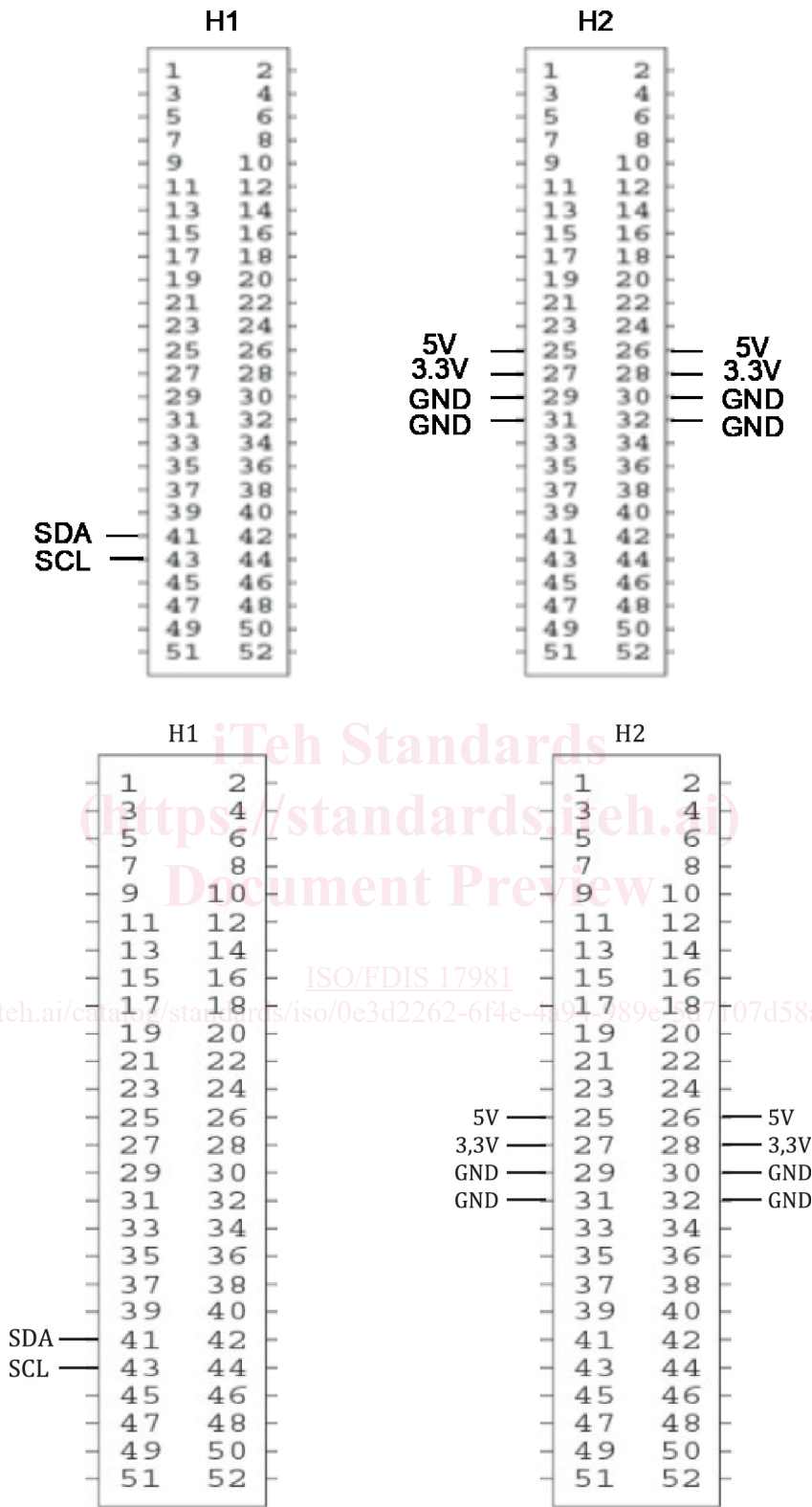


Figure 3 — PC-104 style pin assignment